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November 2013

FDP18N20F / FDPF18N20FT N-Channel UniFETTM FRFET[®] MOSFET 200 V, 18 A, 140 m Ω



Features

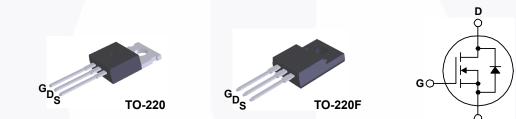
- $R_{DS(on)}$ = 120 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 9 A
- Low Gate Charge (Typ. 20 nC)
- Low C_{rss} (Typ. 24 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- LCD/LED TV
- Consumer Appliances
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET[®] MOSFET has been enhanced by lifetime control. Its t_{rr} is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp balasts.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

	FDP18N20F	FDPF18N20FT	Unit		
Drain to Source Voltage	2	V			
Gate to Source Voltage	±	V			
DrainCurrent	- Continuous (T _C = 25°C)		18	18*	^
DrainCurrent	- Continuous (T _C = 100 ^o C)		10.8	10.8*	A
Drain Current	- Pulsed	(Note 1)	72	72*	А
Single Pulsed Avalanche Energy (Note 2)			324		mJ
Avalanche Current		(Note 1)	18		Α
Repetitive Avalanche Energy (Note 1)		10		mJ	
Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns	
Dower Dissinction	(T _C = 25°C)		100	41	W
Power Dissipation	- Derate Above 25°C		0.83	0.33	W/ºC
Operating and Storage Temperature Range			-55 to +150		°C
Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds 300			00	٥C	
	Gate to Source Voltage Drain Current Drain Current Single Pulsed Avalanche Avalanche Current Repetitive Avalanche En Peak Diode Recovery dv Power Dissipation Operating and Storage T	$\begin{tabular}{ c c c c } \hline Gate to Source Voltage & & & \\ \hline Drain Current & & - Continuous (T_C = 25^\circ C) & \\ \hline - Continuous (T_C = 100^\circ C) & \\ \hline - Continuous (T_C = 100^\circ C) & \\ \hline - Pulsed & & \\ \hline Single Pulsed Avalanche Energy & & \\ \hline Avalanche Current & & \\ \hline Repetitive Avalanche Energy & & \\ \hline Peak Diode Recovery dv/dt & & \\ \hline Power Dissipation & & & \\ \hline Operating and Storage Temperature Range & & \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c } \hline & & & & & & & & & & & & & & & & & & $	$\begin{array}{c c c c c c c } \hline Drain to Source Voltage & & & & & & & & & & & & & & & & & & &$	$\begin{array}{c c c c c c } \hline Drain to Source Voltage & 200 \\ \hline Gate to Source Voltage & \pm 30 \\ \hline Gate to Source Voltage & & \pm 30 \\ \hline Gate to Source Voltage & & & \pm 30 \\ \hline Drain Current & - Continuous (T_C = 25^{\circ}C) & 18 & 18^{*} \\ \hline - Continuous (T_C = 100^{\circ}C) & 10.8 & 10.8^{*} \\ \hline Drain Current & - Pulsed & (Note 1) & 72 & 72^{*} \\ \hline Single Pulsed Avalanche Energy & (Note 2) & & & & & \\ \hline Avalanche Current & (Note 1) & 18 \\ \hline Repetitive Avalanche Energy & (Note 1) & 10 \\ \hline Peak Diode Recovery dv/dt & (Note 3) & & & & \\ \hline Power Dissipation & & & & & & \\ \hline Power Dissipation & & & & & & \\ \hline Operating and Storage Temperature Range & & & & & & & & \\ \hline \end{array}$

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FDP18N20F	FDPF18N20FT	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.2	3.0	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	°C/VV

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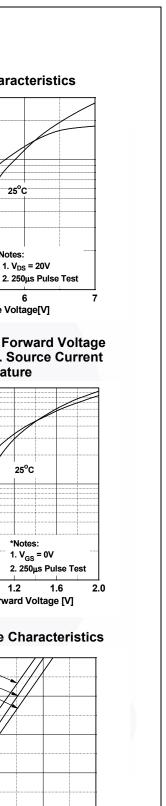
r art Nu	Part Number Top Mark		Packa	ge Packing Method	Reel Size	e Ta	ape Width	Qua	antity
FDP18N20F FDP18N20F		TO-22	TO-220 Tube N/A		N/A		50 units		
		TO-220	TO-220F Tube N/A		N/A		50 units		
Electrica	l Chara	acteristics T _c = 25°C	unless	otherwise noted					
Symbol		Parameter		Test Condition	s	Min.	Тур.	Max.	Unit
Off Charac	cteristics								
BV _{DSS}	Drain to Source Breakdown Voltage			I _D = 250 μA, V _{GS} = 0 V, T	_ = 25°C	200	-	-	V
ΔBV _{DSS} /ΔTJ	Breakdown Voltage Temperature Coefficient			$I_D = 250 \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		-	0.2	-	V/ºC
				V _{DS} = 200 V, V _{GS} = 0 V		-	-	10	
IDSS	Zero Gat	te Voltage Drain Current		V _{DS} = 160 V, T _C = 125 ^o C		-	-	100	μA
I _{GSS}	Gate to E	Gate to Body Leakage Current		V_{GS} = ±30 V, V_{DS} = 0 V		-	-	±100	nA
On Charac	teristics								
V _{GS(th)}	Gate Thr	ate Threshold Voltage		V _{GS} = V _{DS} , I _D = 250 μA		3.0	-	5.0	V
R _{DS(on)}	Static Dr	Static Drain to Source On Resistance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9 \text{ A}$		-	0.12	0.14	Ω
9 _{FS}	Forward	orward Transconductance		$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 9 \text{ A}$			13.6	-	S
Dynamic C C _{iss}	Input Ca	pacitance		V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		-	885	1180	pF
C _{oss}		apacitance				-	200	270	pF
	Deverse								
		Transfer Capacitance	_			-	24	35	pF
Q _{g(tot)}	Total Gat	te Charge at 10V		V _{DS} = 160 V, I _D = 18 A,		-	20	26	nC
Q _{gs}	Total Gat Gate to S	te Charge at 10V Source Gate Charge		V _{DS} = 160 V, I _D = 18 A, V _{GS} = 10 V		-	20 5		nC nC
Q _{g(tot)} Q _{gs}	Total Gat Gate to S	te Charge at 10V			(Note 4)		20	26	nC
Q _{g(tot)} Q _{gs} Q _{gd}	Total Gat Gate to S Gate to D	te Charge at 10V Source Gate Charge Drain "Miller" Charge			(Note 4)		20 5	26	nC nC
Q _{g(tot)} Q _{gs} Q _{gd}	Total Gat Gate to S Gate to D Characte Turn-On	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time		V _{GS} = 10 V	(Note 4)		20 5 9 16	26 - - 40	nC nC
Qg(tot) Qgs Qgd Switching t _{d(on)}	Total Gat Gate to S Gate to D Characte Turn-On Turn-On	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time		V _{GS} = 10 V V _{DD} = 100 V, I _D = 18 A,	(Note 4)		20 5 9 16 50	26 - - 40 110	nC nC nC
Qg(tot) Qgs Qgd Switching td(on)	Total Gat Gate to S Gate to D Characto Turn-On Turn-On Turn-Off	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time Delay Time		V _{GS} = 10 V	(Note 4)	-	20 5 9 16 50 50	26 - - 40 110 110	nC nC nC
$\begin{array}{c} Q_{g(tot)} \\ Q_{gs} \\ Q_{gd} \\ \hline \\ \textbf{Switching} \\ \hline \\ t_{d(on)} \\ t_r \\ \hline \\ t_{d(off)} \\ \hline \end{array}$	Total Gat Gate to S Gate to D Characto Turn-On Turn-On Turn-Off	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time		V _{GS} = 10 V V _{DD} = 100 V, I _D = 18 A,	(Note 4)	-	20 5 9 16 50	26 - - 40 110	nC nC nC nS ns
$\begin{array}{c} \underline{Q_{g(tot)}} \\ \overline{Q_{gs}} \\ \overline{Q_{gd}} \\ \hline \\$	Total Gat Gate to S Gate to D Characto Turn-On Turn-On Turn-Off Turn-Off	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time Delay Time		V _{GS} = 10 V V _{DD} = 100 V, I _D = 18 A,		- - - -	20 5 9 16 50 50	26 - - 40 110 110	nC nC nC nS ns
Qg(tot) Qgs Qgd Switching td(on) tr td(off) tf Drain-Soul	Total Gat Gate to S Gate to D Characto Turn-On Turn-Off Turn-Off Turn-Off	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time Delay Time Fall Time	e Diode	$V_{GS} = 10 V$ $V_{DD} = 100 V, I_D = 18 A,$ $V_{GS} = 10 V, R_G = 25 \Omega$		- - - -	20 5 9 16 50 50	26 - - 40 110 110	nC nC nC nS ns
$\begin{array}{c} \underline{Q}_{g(tot)} \\ \overline{Q}_{gs} \\ \overline{Q}_{gd} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_{r} \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_{f} \\ \hline \textbf{Drain-Soul} \\ \hline \end{array}$	Total Gat Gate to S Gate to D Characto Turn-On Turn-Off Turn-Off Turn-Off Turn-Off Maximur	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time Delay Time Fall Time e Characteristics		$V_{GS} = 10 V$ $V_{DD} = 100 V, I_{D} = 18 A,$ $V_{GS} = 10 V, R_{G} = 25 \Omega$ Forward Current		· · · ·	20 5 9 16 50 50 40	26 - - 40 110 110 90	nC nC nC nS ns ns ns
Qg(tot) Qgs Qgd Switching td(on) tr td(off) tf Drain-Sour Is IsM	Total Gat Gate to S Gate to D Characte Turn-On Turn-Off Turn-Off Turn-Off Turn-Off Maximurr Maximurr	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time Delay Time Fall Time e Characteristics n Continuous Drain to Source	ode For	$V_{GS} = 10 V$ $V_{DD} = 100 V, I_{D} = 18 A,$ $V_{GS} = 10 V, R_{G} = 25 \Omega$ Forward Current		· · · ·	20 5 9 16 50 50 40	26 - - 40 110 110 90 18	nC nC nC nS ns ns ns A
$\frac{Q_{g(tot)}}{Q_{gs}}$ $\frac{Q_{gd}}{Switching}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ Drain-Sour	Total Gat Gate to S Gate to D Characto Turn-On Turn-Off Turn-Off Turn-Off Turn-Off Maximur Maximur Drain to S	te Charge at 10V Source Gate Charge Drain "Miller" Charge eristics Delay Time Rise Time Delay Time Fall Time e Characteristics n Continuous Drain to Source n Pulsed Drain to Source Did	ode For	$V_{GS} = 10 V$ $V_{DD} = 100 V, I_{D} = 18 A,$ $V_{GS} = 10 V, R_{G} = 25 \Omega$ Forward Current ward Current		· · · · ·	20 5 9 16 50 50 40 - -	26 - - 40 110 110 90 18 72	nC nC nC nS ns ns ns A A

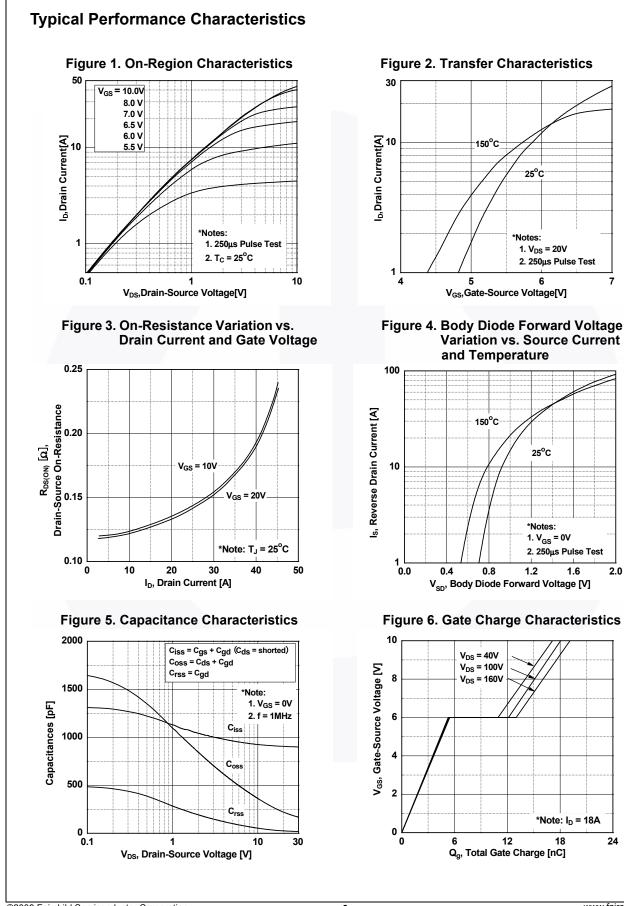
Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.

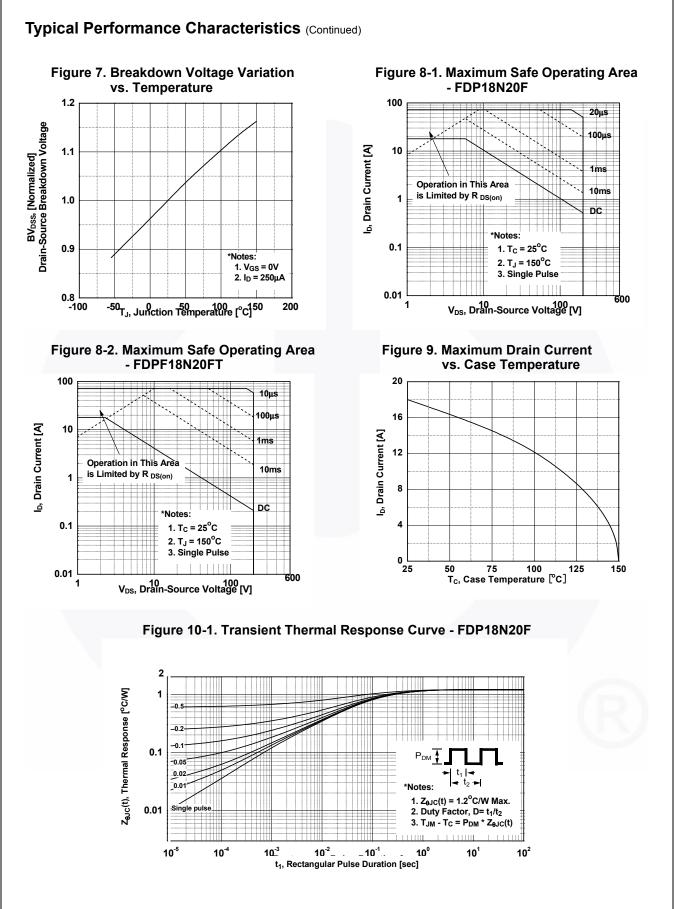
2. L = 2 mH, I_{AS} = 18 A, V_{DD} = 50 V, R_G = 2 5Ω, starting T_J = 25°C. 3. I_{SD} ≤ 18 A, di/dt ≤ 200 A/µs, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature typical characteristics.

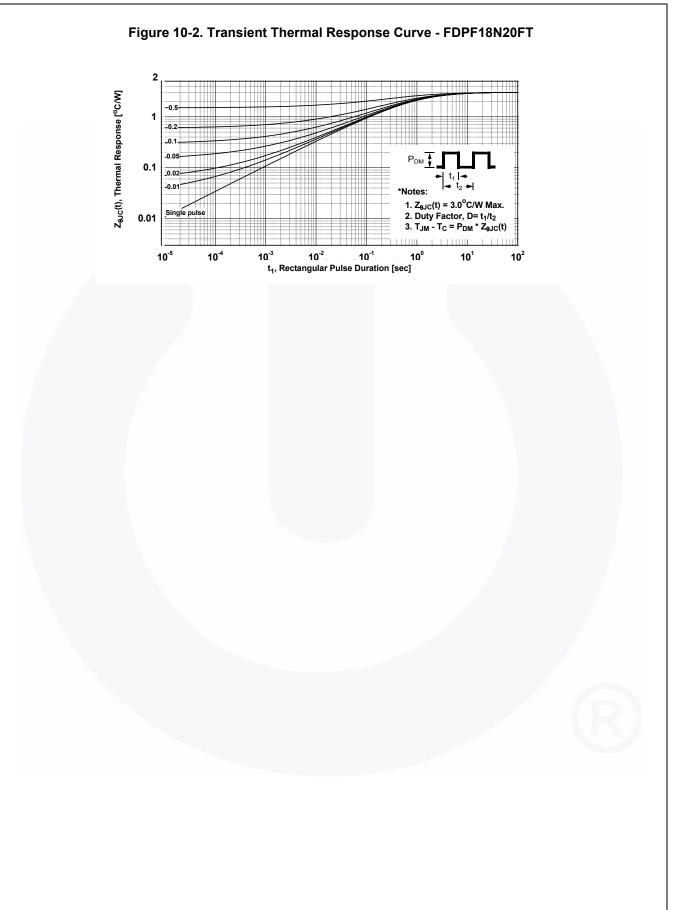
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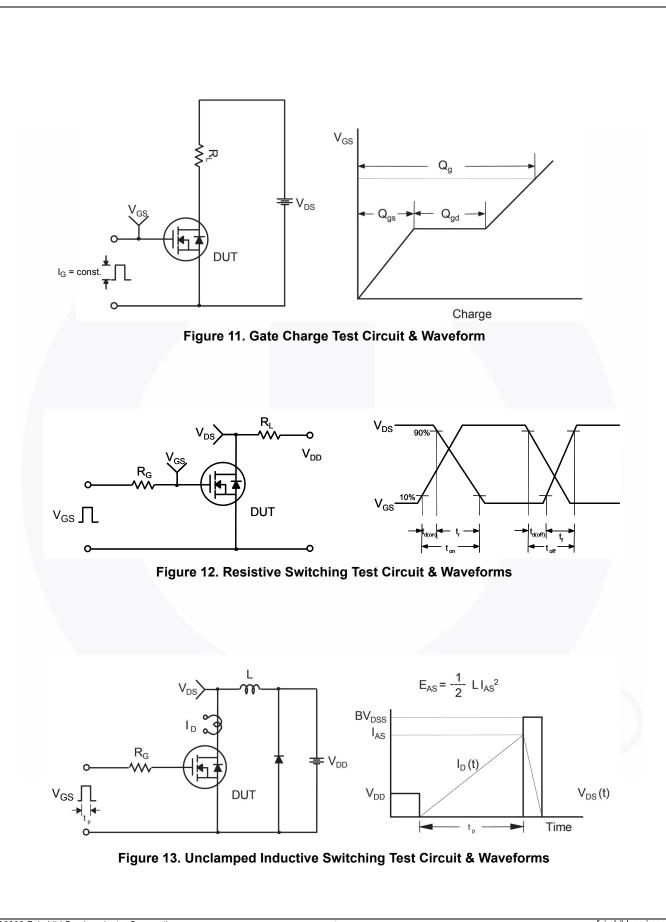




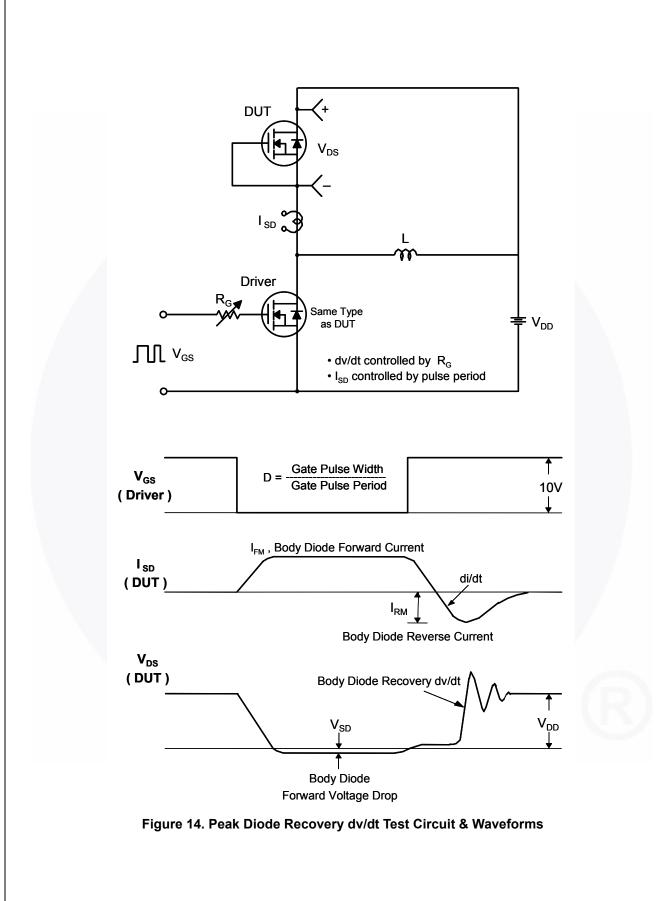
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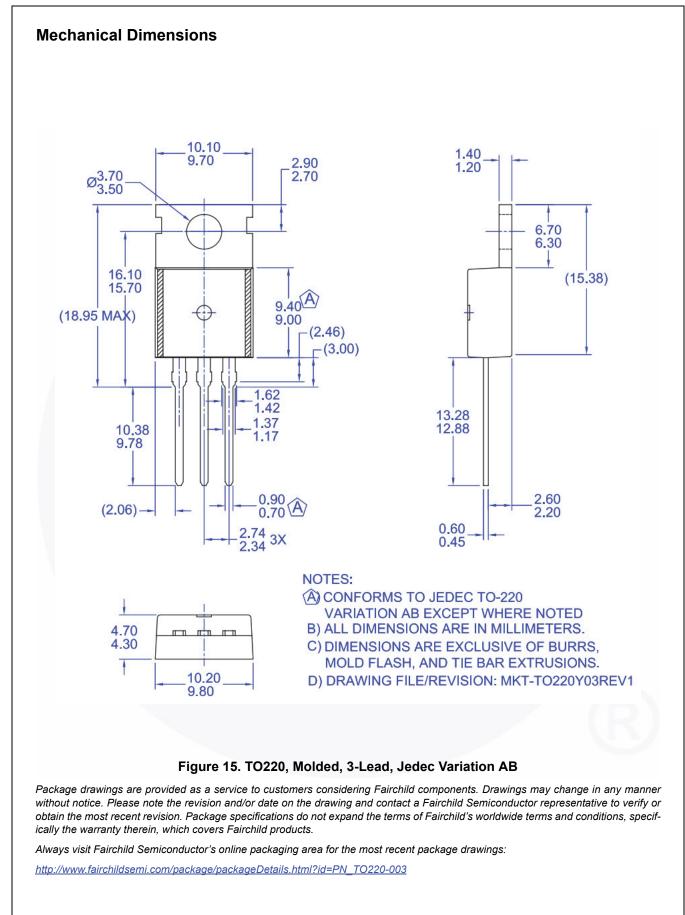


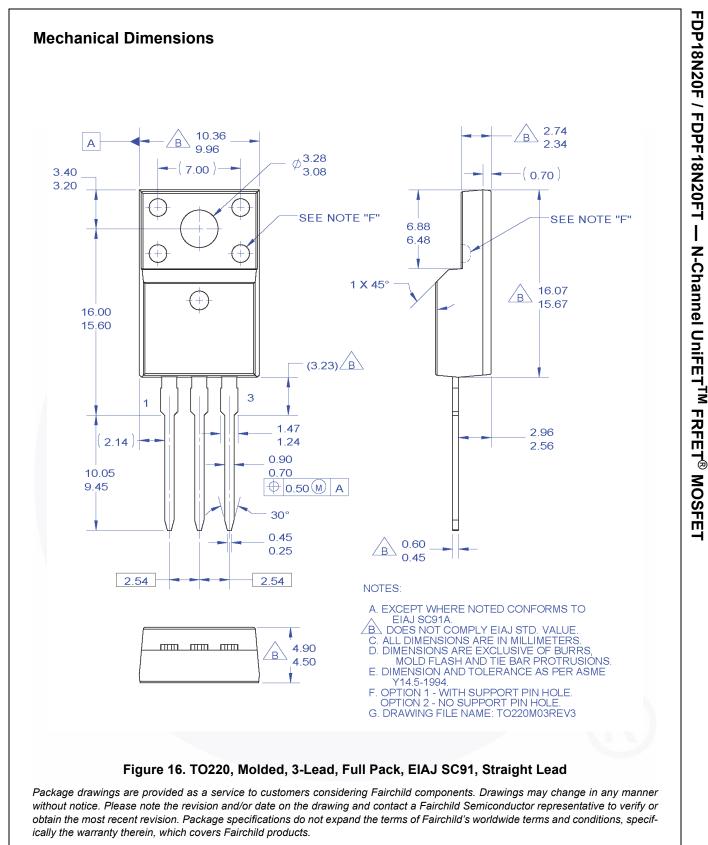




FDP18N20F / FDPF18N20FT — N-Channel UniFETTM FRFET[®] MOSFET







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